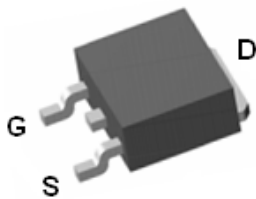


# P8010BD

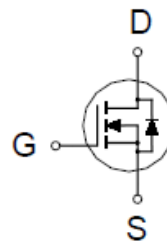
## N-Channel Enhancement Mode MOSFET

### PRODUCT SUMMARY

$V_{(BR)DSS}$	$R_{DS(ON)}$	$I_D$
100V	85mΩ @ $V_{GS} = 10V$	15A



TO-252



### ABSOLUTE MAXIMUM RATINGS ( $T_A = 25\text{ °C}$ Unless Otherwise Noted)

PARAMETERS/TEST CONDITIONS		SYMBOL	LIMITS	UNITS
Drain-Source Voltage		$V_{DS}$	100	V
Gate-Source Voltage		$V_{GS}$	±20	V
Continuous Drain Current	$T_C = 25\text{ °C}$	$I_D$	15	A
	$T_C = 100\text{ °C}$		9	
Pulsed Drain Current <sup>1</sup>		$I_{DM}$	35	
Avalanche Current		$I_{AS}$	12	
Avalanche Energy	$L = 0.1\text{mH}$	$E_{AS}$	7.2	mJ
MOSFET dV/dt Ruggedness		dV/dt	16.2	V/nS
Peak Diode Recovery dV/dt <sup>2</sup>			4.1	
Power Dissipation	$T_C = 25\text{ °C}$	$P_D$	46	W
	$T_C = 100\text{ °C}$		18	
Junction & Storage Temperature Range		$T_J, T_{stg}$	-55 to 150	°C

### THERMAL RESISTANCE RATINGS

THERMAL RESISTANCE	SYMBOL	TYPICAL	MAXIMUM	UNITS
Junction-to-Case	$R_{\theta JC}$		2.7	°C / W

<sup>1</sup>Pulse width limited by maximum junction temperature.

<sup>2</sup> $I_D = 15A, di/dt = 100A/\mu S, V_{DD} < BV_{DSS}, \text{Starting } T_J = 25\text{ °C}$

## P8010BD

### N-Channel Enhancement Mode MOSFET

#### ELECTRICAL CHARACTERISTICS (T<sub>J</sub> = 25 °C, Unless Otherwise Noted)

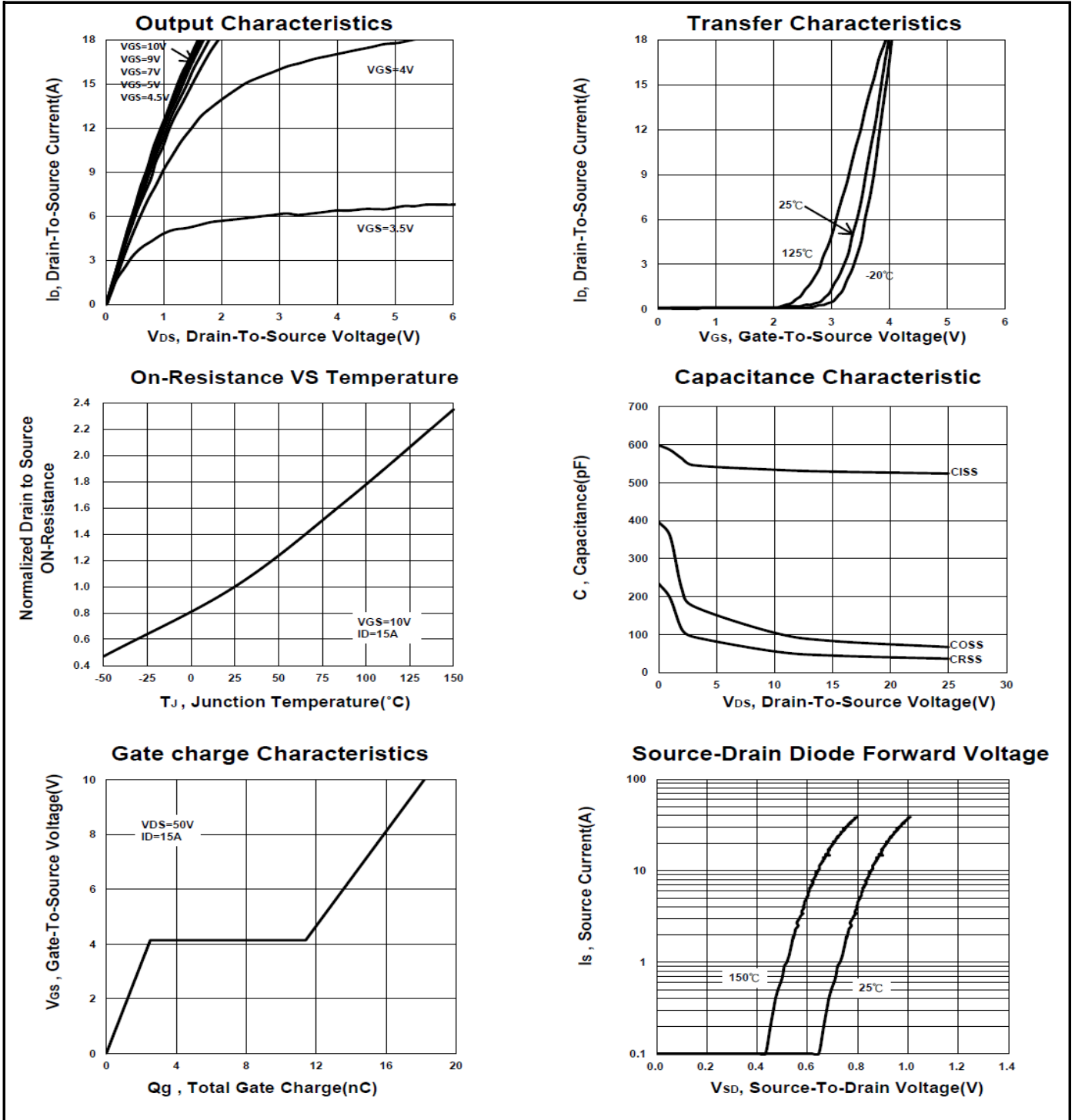
PARAMETER	SYMBOL	TEST CONDITIONS	LIMITS			UNITS
			MIN	TYP	MAX	
<b>STATIC</b>						
Drain-Source Breakdown Voltage	V <sub>(BR)DSS</sub>	V <sub>GS</sub> = 0V, I <sub>D</sub> = 250μA	100			V
Gate Threshold Voltage	V <sub>GS(th)</sub>	V <sub>DS</sub> = V <sub>GS</sub> , I <sub>D</sub> = 250μA	1.3	1.8	2.3	
Gate-Body Leakage	I <sub>GSS</sub>	V <sub>DS</sub> = 0V, V <sub>GS</sub> = ±20V			±100	nA
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	V <sub>DS</sub> = 80V, V <sub>GS</sub> = 0V			1	μA
		V <sub>DS</sub> = 80V, V <sub>GS</sub> = 0V, T <sub>J</sub> = 125 °C			10	
On-State Drain Current <sup>1</sup>	I <sub>D(ON)</sub>	V <sub>DS</sub> = 5V, V <sub>GS</sub> = 10V	35			A
Drain-Source On-State Resistance <sup>1</sup>	R <sub>DS(ON)</sub>	V <sub>GS</sub> = 4.5V, I <sub>D</sub> = 10A		67	95	mΩ
		V <sub>GS</sub> = 10V, I <sub>D</sub> = 15A		61	85	
Forward Transconductance <sup>1</sup>	g <sub>fs</sub>	V <sub>DS</sub> = 5V, I <sub>D</sub> = 15A		25		S
<b>DYNAMIC</b>						
Input Capacitance	C <sub>iss</sub>	V <sub>GS</sub> = 0V, V <sub>DS</sub> = 25V, f = 1MHz		527		pF
Output Capacitance	C <sub>oss</sub>			68		
Reverse Transfer Capacitance	C <sub>rss</sub>			37		
Gate Resistance	R <sub>g</sub>	V <sub>GS</sub> = 0V, V <sub>DS</sub> = 0V, f = 1MHz		1.5		Ω
Total Gate Charge <sup>2</sup>	Q <sub>g</sub>	V <sub>GS</sub> = 10V, V <sub>DS</sub> = 0.5V <sub>(BR)DSS</sub> , I <sub>D</sub> = 15A		18.5		nC
Gate-Source Charge <sup>2</sup>	Q <sub>gs</sub>			2.7		
Gate-Drain Charge <sup>2</sup>	Q <sub>gd</sub>			5.1		
Turn-On Delay Time <sup>2</sup>	t <sub>d(on)</sub>	V <sub>DS</sub> = 40V, I <sub>D</sub> ≅ 15A, V <sub>GS</sub> = 10V, R <sub>GEN</sub> = 6Ω		11		nS
Rise Time <sup>2</sup>	t <sub>r</sub>			48		
Turn-Off Delay Time <sup>2</sup>	t <sub>d(off)</sub>			80		
Fall Time <sup>2</sup>	t <sub>f</sub>			73		
<b>SOURCE-DRAIN DIODE RATINGS AND CHARACTERISTICS (T<sub>J</sub> = 25 °C)</b>						
Continuous Current	I <sub>S</sub>				15	A
Forward Voltage <sup>1</sup>	V <sub>SD</sub>	I <sub>F</sub> = 15A, V <sub>GS</sub> = 0V			1.1	V
Reverse Recovery Time	t <sub>rr</sub>	I <sub>F</sub> = 15A, di <sub>F</sub> /dt = 100A / μS		33		nS
Reverse Recovery Charge	Q <sub>rr</sub>				35	

<sup>1</sup>Pulse test : Pulse Width ≤ 300 μsec, Duty Cycle ≤ 2%.

<sup>2</sup>Independent of operating temperature.

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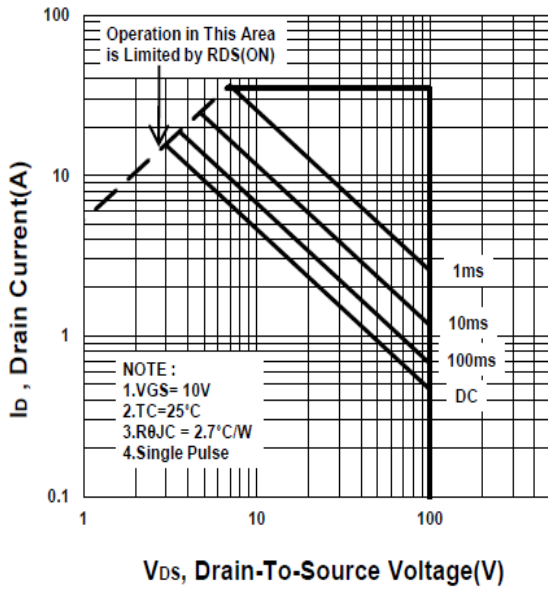
## N-Channel Enhancement Mode MOSFET



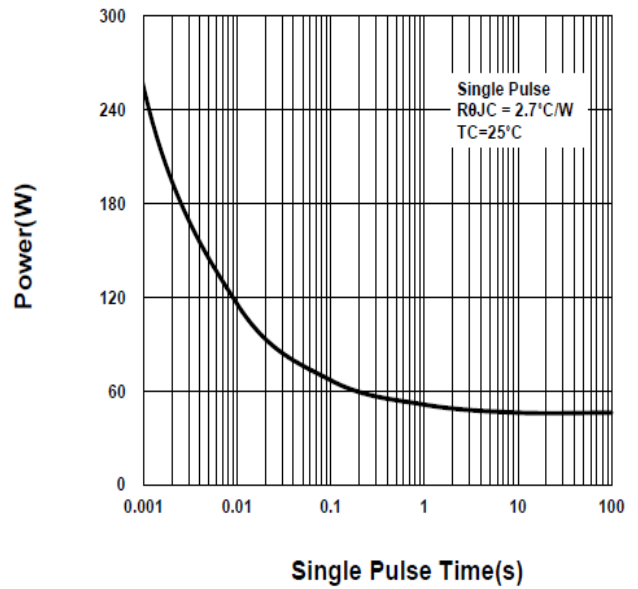
# P8010BD

## N-Channel Enhancement Mode MOSFET

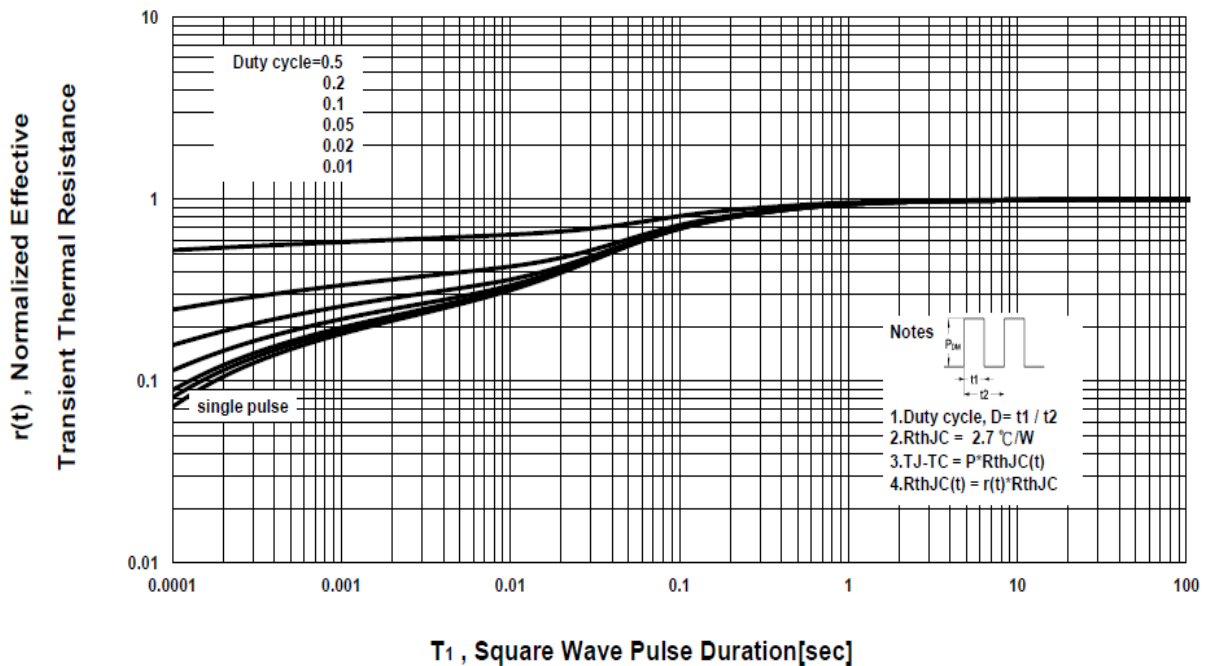
**Safe Operating Area**



**Single Pulse Maximum Power Dissipation**



**Transient Thermal Response Curve**



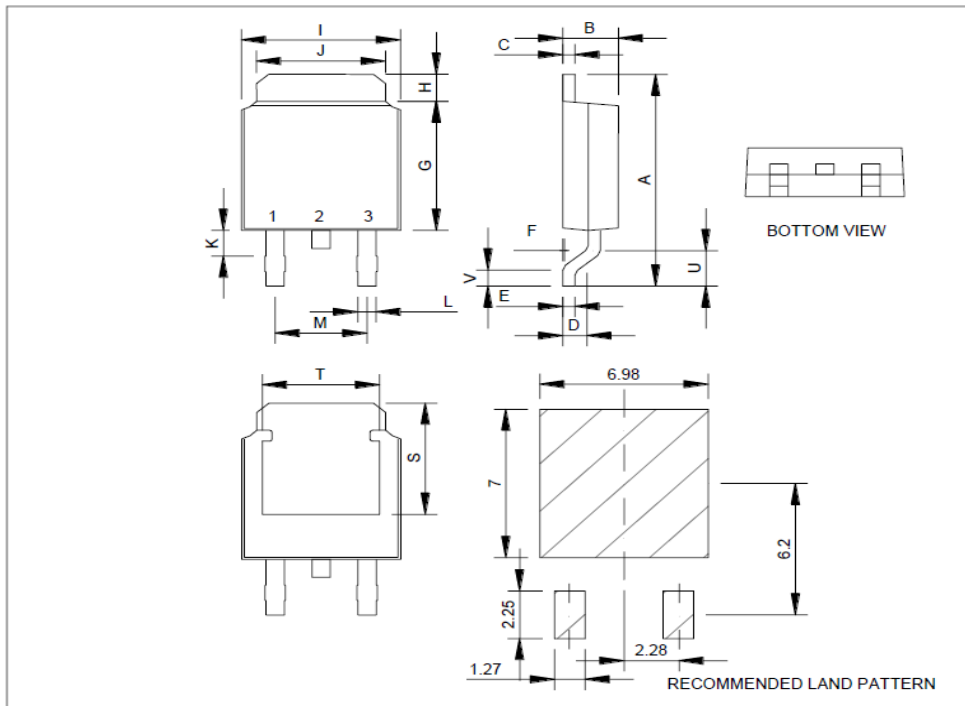
# P8010BD

## N-Channel Enhancement Mode MOSFET

### Package Dimension

### TO-252 (DPAK) MECHANICAL DATA

Dimension	mm			Dimension	mm		
	Min.	Typ.	Max.		Min.	Typ.	Max.
A	8.9	10	10.41	J	4.8		5.64
B	2.1	2.2	2.4	K	0.15		1.1
C	0.4	0.5	0.61	L	0.4	0.76	0.89
D	0.82	1.2	1.5	M	4.2	4.58	5
E	0.4	0.5	0.61	S	4.9	5.1	5.3
F	0		0.2	T	4.6	4.75	5.44
G	5.3	6.1	6.3	U	1.4		1.78
H	0.9		1.7	V	0.55	1.25	1.7
I	6.3	6.5	6.8				



\*因为各家封装模具不同而外观略有所差异，不影响电性及Layout。